

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT7552624

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YU-TAI TSAI	09/21/2022
RECEIVING PARTY DATA	
Name:	MEDIATEK INC.
Street Address:	NO. 1, DUSING 1ST ROAD
Internal Address:	HSINCHU SCIENCE PARK
City:	HSINCHU CITY
State/Country:	TAIWAN
Postal Code:	30078
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17892114
CORRESPONDENCE DATA	
Fax Number:	(206)792-5742
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	MDTK.0655US
NAME OF SUBMITTER:	ANDY M. HAN
SIGNATURE:	/Andy M. Han/
DATE SIGNED:	09/22/2022
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 3	
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source=MDTK_0655US_Combined_Declaration_Assignment#page2.tif	
source=MDTK_0655US_Combined_Declaration_Assignment#page3.tif	

ASSIGNMENT

PARTIES TO THE ASSIGNMENT

Assignor(s):

1. Yu-Tai Tsai

Assignee:

MediaTek Inc.
No. 1, Dusing 1st Road, Hsinchu Science Park
Hsinchu City 30078, Taiwan, R.O.C.

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of the above-identified invention for which:

provisional application(s) for United States Letters Patent was/were filed on

08 March 2022 and was/were given U.S. Serial No(s). **63/317,563**; and/or

a non-provisional application for United States Letters Patent was/is:

filed on _____ and was given U.S. Serial No. _____; or filed concurrently herewith.

Assignors hereby authorize and request ASSIGNEE's legal representatives, who are associated with customer number **13859**, to handle all matters related to the above-identified application.

WHEREAS, MediaTek Inc. (hereinafter referred to as ASSIGNEE), a corporation of Taiwan, Republic of China (R.O.C.) having a place of business at No. 1, Dusing 1st Road, Hsinchu Science Park, Hsinchu City 30078, Taiwan, R.O.C., is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

Legal Name of First-Named Inventor: Yu-Tai TSAI	
Inventor's Signature: Yu-Tai Tsai	Date: 2022/09/21
Residence: Hsinchu City, Taiwan, R.O.C.	
Nationality: Taiwan, R.O.C.	
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